

SOP4, DC Input Photo Transistor Coupler

Description

The FX357 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SOP4 package.

With the robust coplanar double mold structure, FX357 series provide the most stable isolation feature.

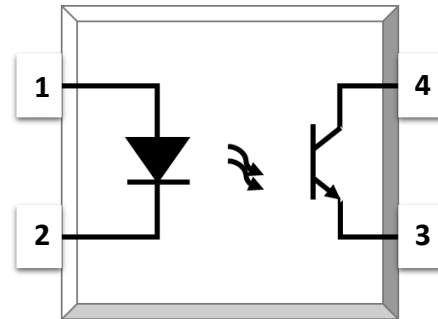
Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1, GB8898

Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

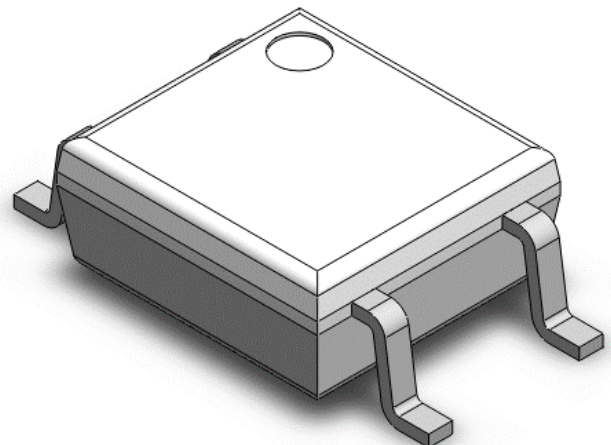
SCHEMATIC



PIN DEFINITION

1. Anode
2. Cathode
3. Emitter
4. Collector

PACKAGE OUTLINE





SOP4, DC Input Photo Transistor Coupler

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	I _F	60	mA	
Peak Forward Current	I _{FP}	1	A	1
Reverse Voltage	V _R	6	V	
Input Power Dissipation	P _I	100	mW	
OUTPUT				
Collector - Emitter Voltage	V _{CEO}	35	V	
Emitter - Collector Voltage	V _{ECO}	7	V	
Collector Current	I _C	50	mA	
Output Power Dissipation	P _O	150	mW	
COMMON				
Total Power Dissipation	P _{tot}	200	mW	
Isolation Voltage	V _{iso}	3750	V _{rms}	2
Operating Temperature	T _{opr}	-55~110	°C	
Storage Temperature	T _{stg}	-55~125	°C	
Soldering Temperature	T _{sol}	260	°C	

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

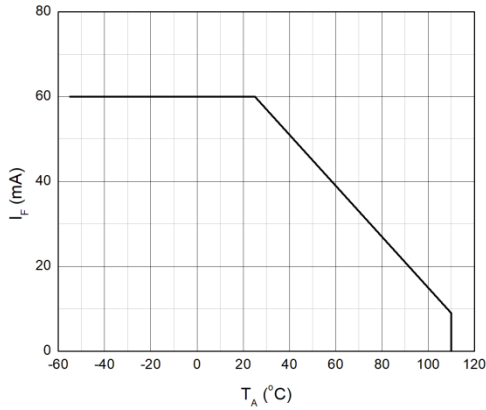
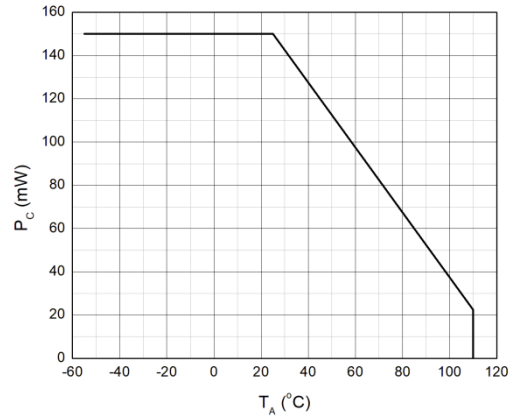
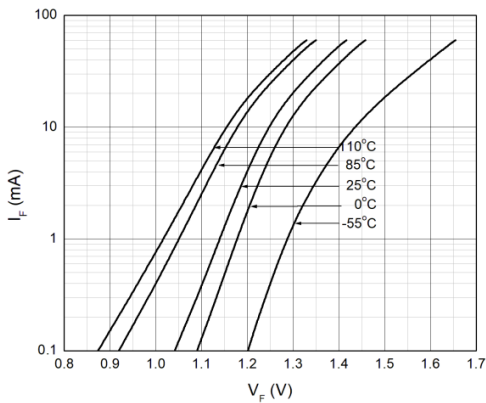
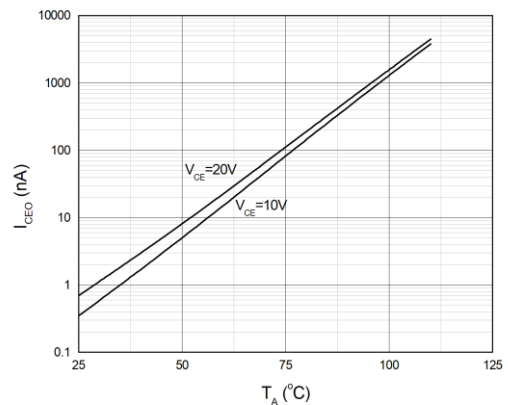
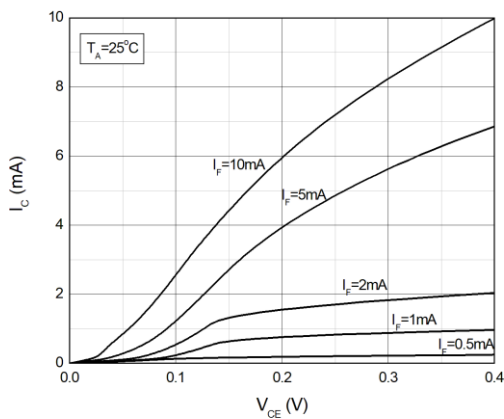
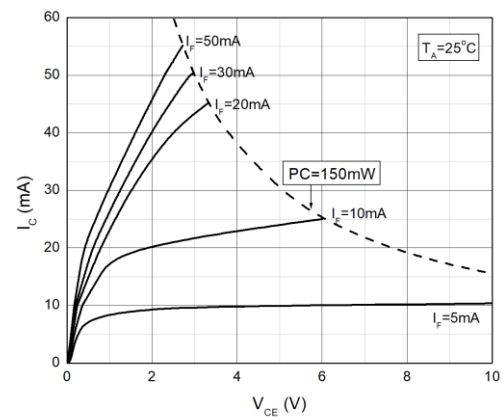


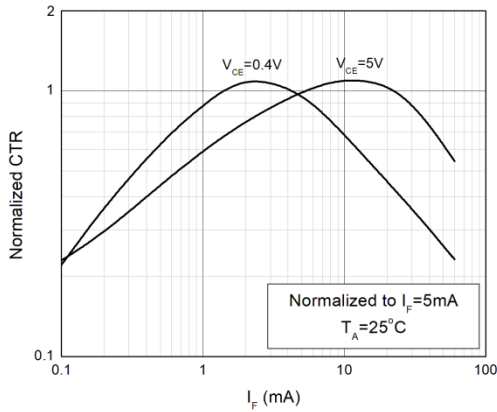
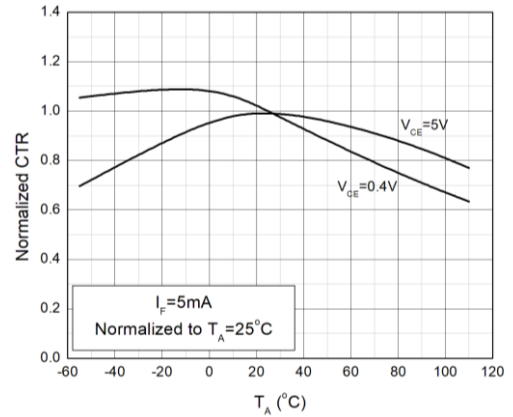
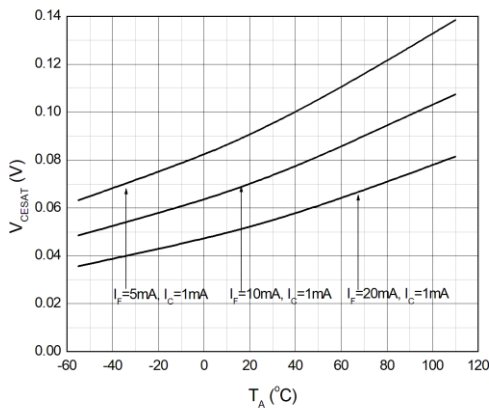
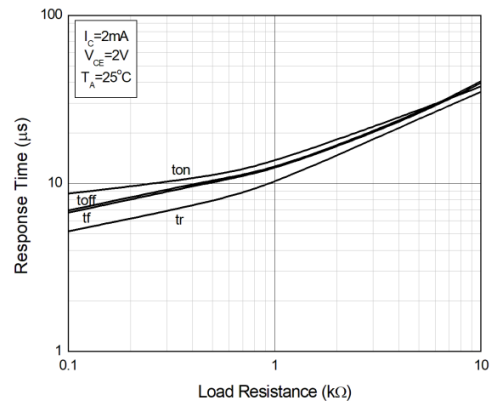
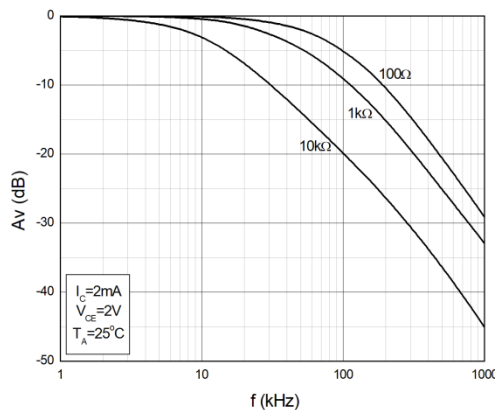
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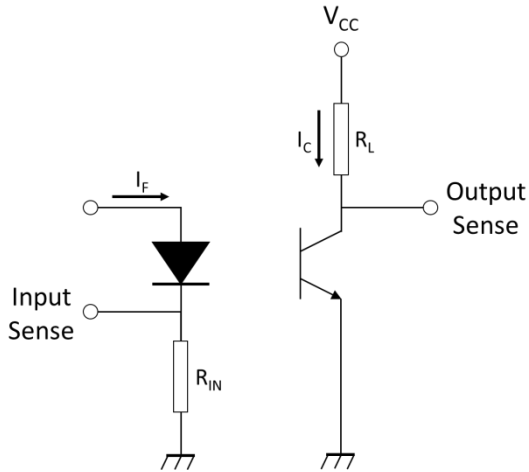
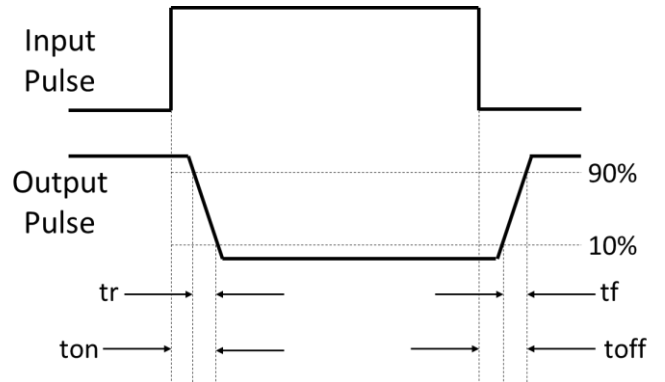
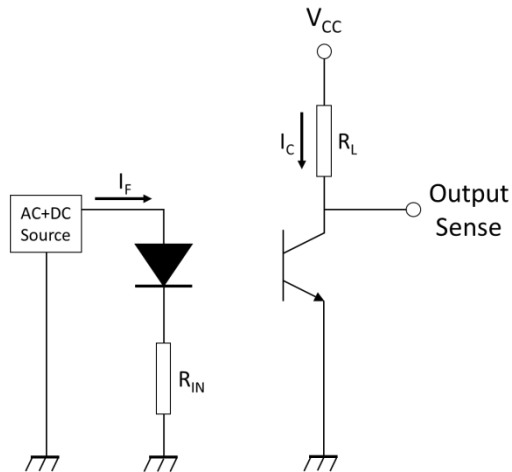
ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V _F	-	1.24	1.4	V	IF=10mA	
Reverse Current	I _R	-	-	10	μA	VR=6V	
Input Capacitance	C _{in}	-	10	-	pF	V=0, f=1kHz	
OUTPUT							
Collector Dark Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0	
Collector-Emitter Breakdown Voltage	BV _{CEO}	35	-	-	V	IC=0.1mA, IF=0	
Emitter-Collector Breakdown Voltage	BV _{ECO}	7	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	FX3570	CTR	50	-	600	%	IF=5mA, VCE=5V
	FX357A		80	-	160		
	FX357B		130	-	260		
	FX357C		200	-	400		
	FX357D		300	-	600		
	FX357E		100	-	200		
Collector-Emitter Saturation Voltage	V _{CE(sat)}	-	0.06	0.2	V	IF=20mA, IC=1mA	
Isolation Resistance	R _{ISO}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C _{io}	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)	t _r	-	3	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)	t _f	-	4	18	μs	RL=100Ω	3
Cut-off Frequency	f _c	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4

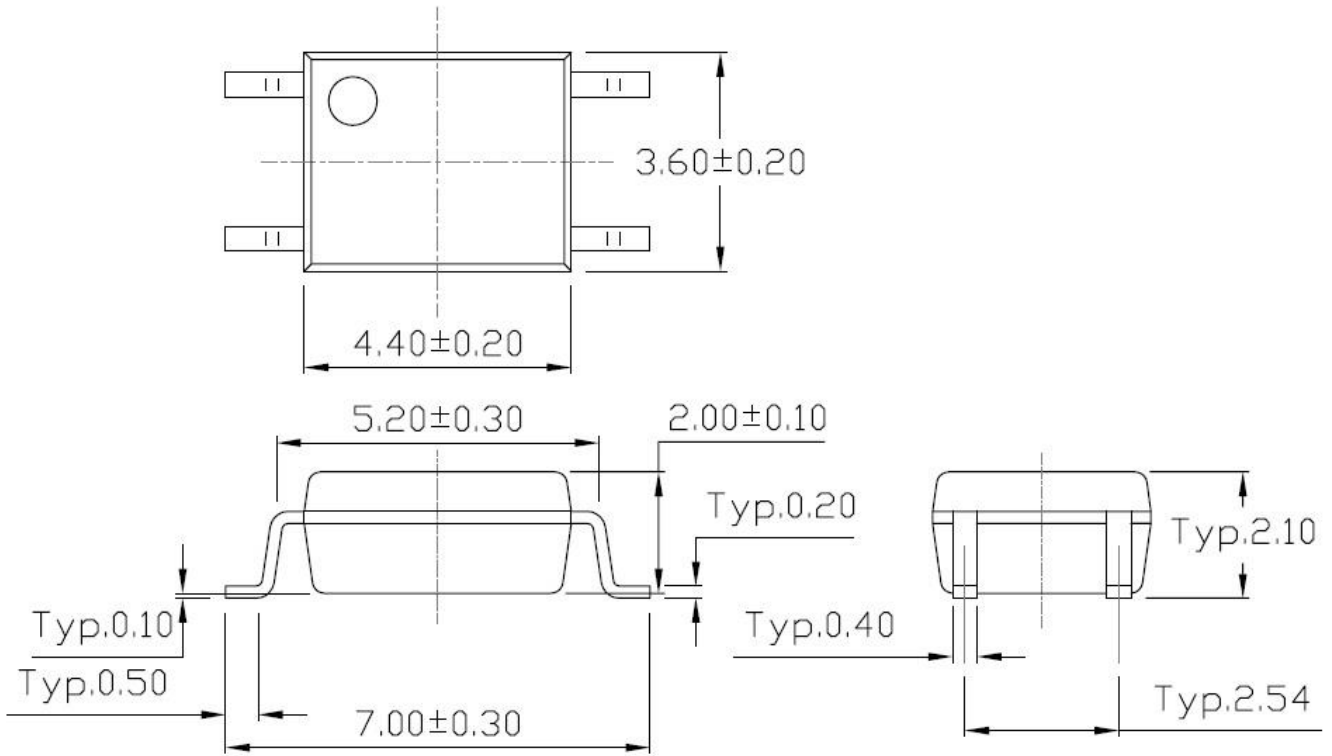
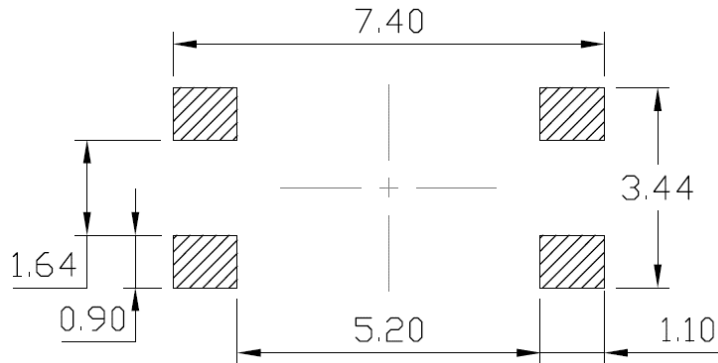
Note 3. Fig.12&13

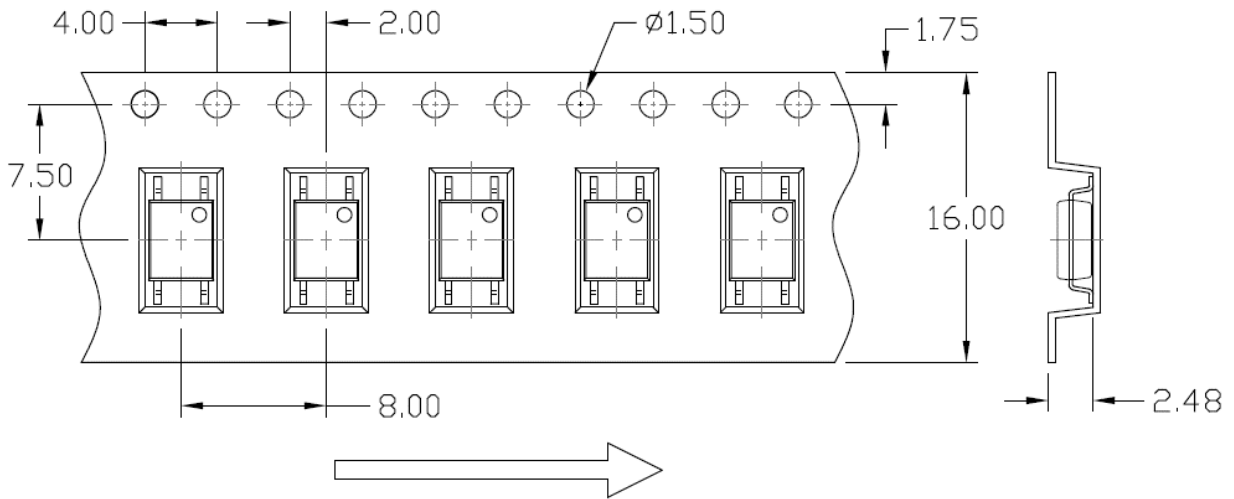
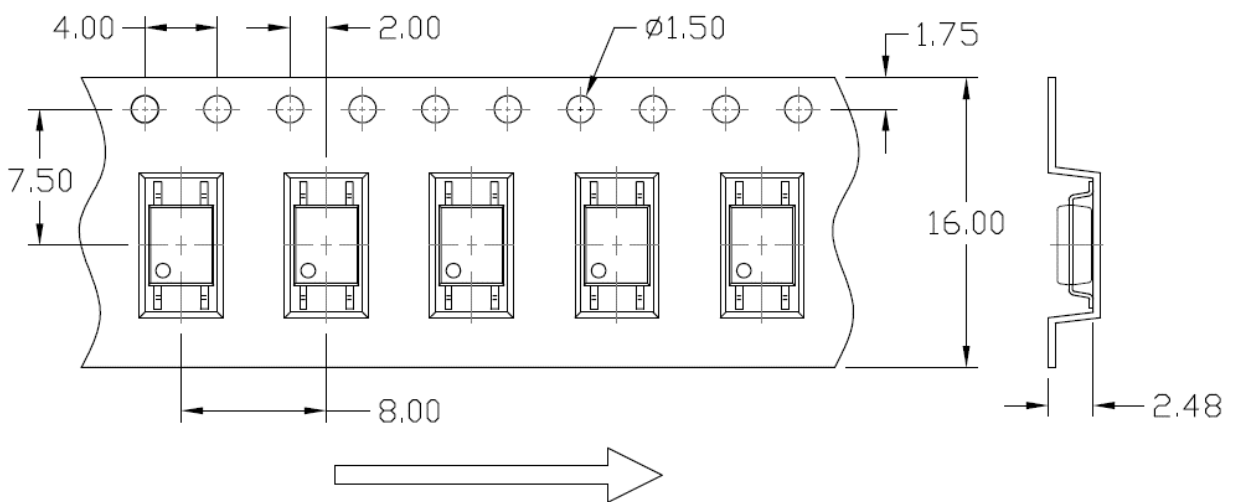
Note 4. Fig.14

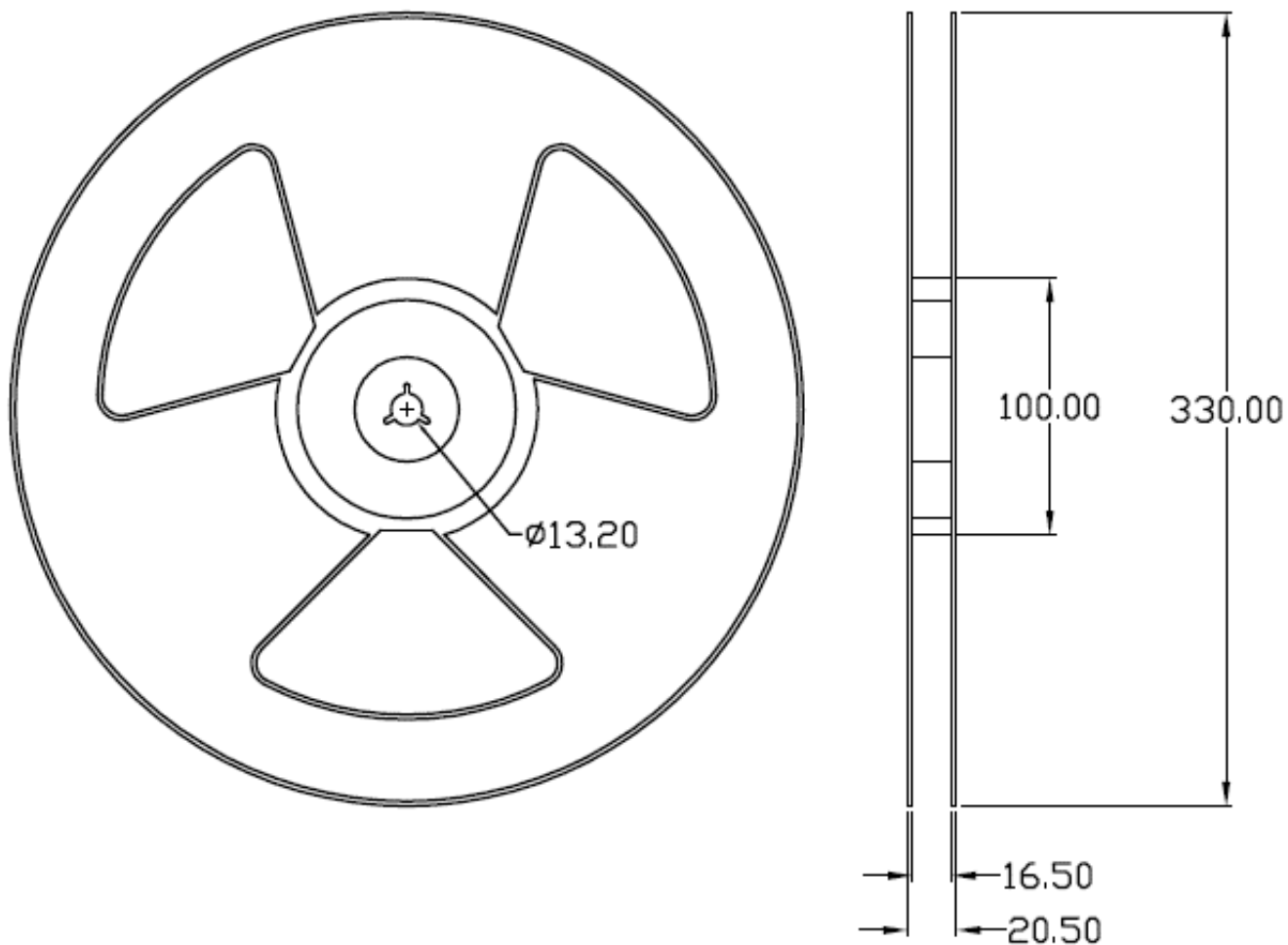
SOP4, DC Input Photo Transistor Coupler
CHARACTERISTIC CURVES
Fig.1 Forward Current vs. Ambient Temperature

Fig.2 Collector Power Dissipation vs. Ambient Temperature

Fig.3 Forward Current vs. Forward Voltage

Fig.4 Collector Dark Current vs. Ambient Temperature

Fig.5 Collector Current vs. Collector-emitter Voltage

Fig.6 Collector Current vs. Collector-emitter Voltage


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CHARACTERISTIC CURVES
Fig.7 Normalized Current Transfer Ratio vs. Forward Current

Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature

Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature

Fig.10 Switching Time vs. Load Resistance

Fig.11 Frequency Response


SOP4, DC Input Photo Transistor Coupler
TEST CIRCUITS
Fig.12 Test Circuits of Response Time

Fig.13 Curves of Response Time

Fig.14 Test Circuits of Frequency Response


SOP4, DC Input Photo Transistor Coupler
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Recommended Solder Mask (Dimensions in mm unless otherwise stated)


SOP4, DC Input Photo Transistor Coupler
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)
Packing Option 1

Packing Option 2


SOP4, DC Input Photo Transistor Coupler
REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)
Reel Dimension


SOP4, DC Input Photo Transistor Coupler

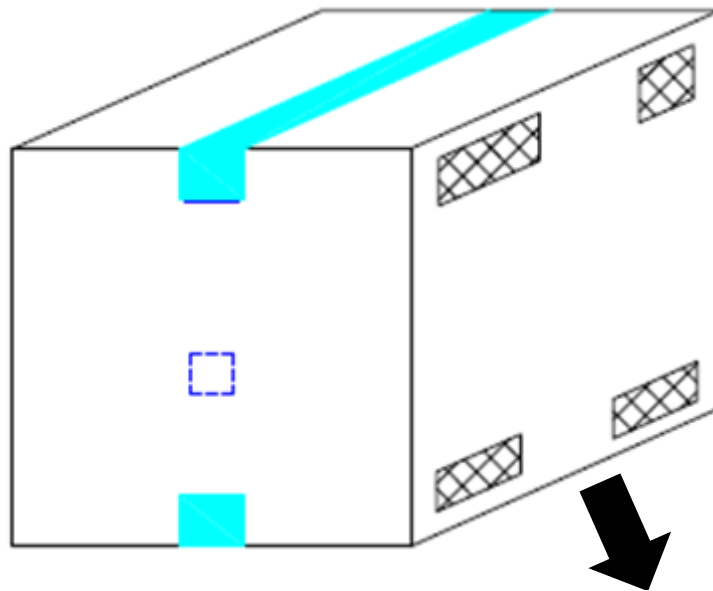
BOX SPECIFICATIONS (Reel Type)

Inner Box



- L x W x H = 36cm x 36cm x 6.9cm

Outer Box



- L x W x H = 45cm x 38cm x 38cm





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ORDERING AND MARKING INFORMATION

MARKING INFORMATION



LYG : Company Abbr.
FX357 : Part Number
R : CTR Rank
V : VDE Option
Y : Fiscal Year
A : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

LABEL INFORMATION

FX357RVBTH-0ZP2GCM

FX357 – Part Number
R – Rank Option(0/A/B/C/D/E)
V – VDE
BTH – Fixed Character
0 – Fixed Character
Z – Packing Option (1/3)
P2 – Fixed Character
G – Material Option
(G: Green Material / None: None Green Material)
C – Color Option(W: White / B: Black)
M – Leadframe Option
(F: Iron Leadframe / None: Copper Leadframe)

LYG Semiconductor label with fields: DEVICE: F*****_****, LOT NO: F4HM74.1-01, DATE CODE: 210101, QTY(EA): 3000, DATE: 2021/02/08. Includes logos for CQC, RoHS/H.F., and a QC Stamp.

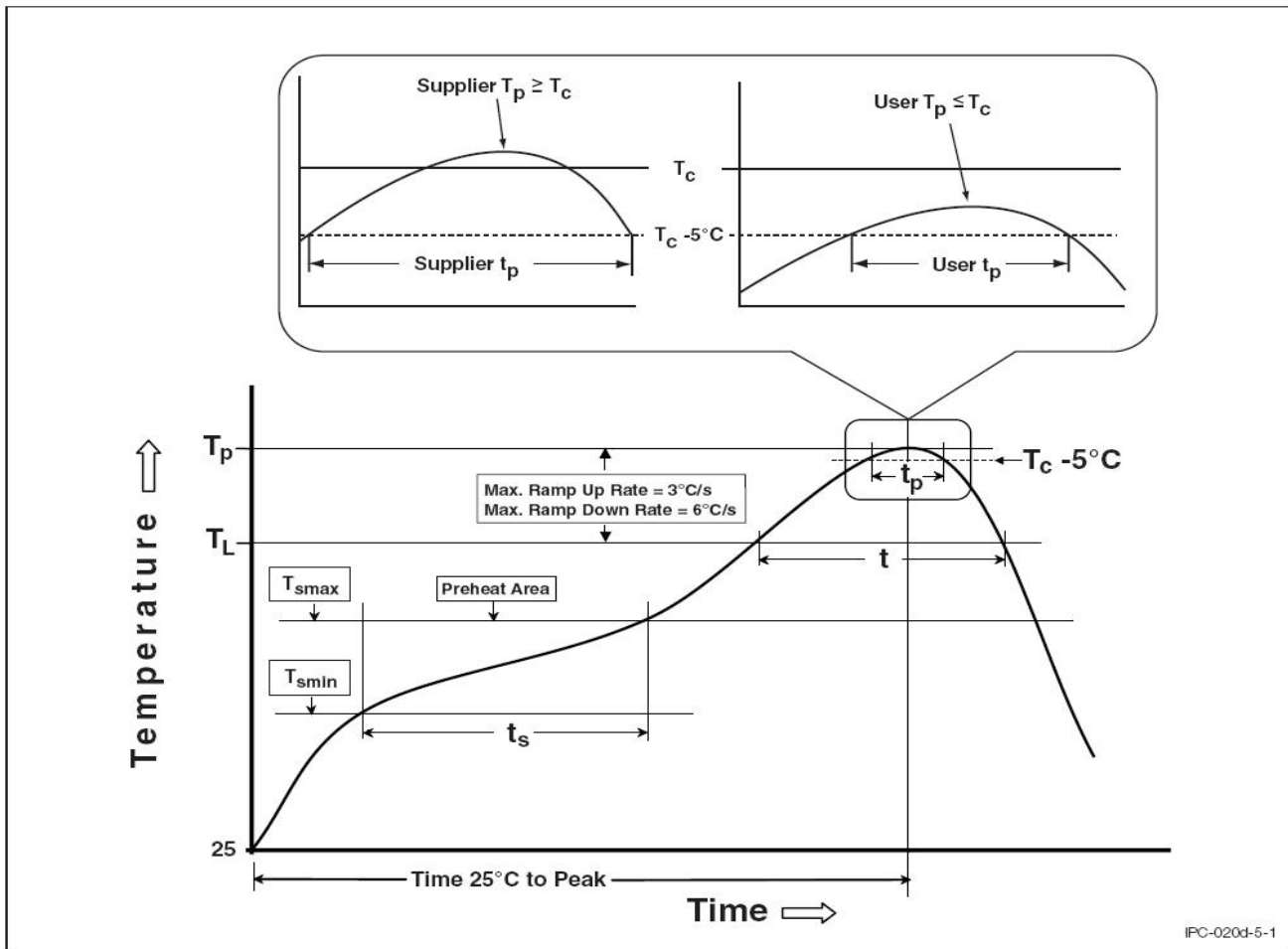
PACKING QUANTITY

Table with 4 columns: Option, Quantity, Quantity – Inner box, Quantity – Outer box. Row 1: Option 1, 3000 Units/Reel, 3 Reels/Inner box, 5 Inner box/Outer box = 45k Units. Row 2: Option 2, 3000 Units/Reel, 3 Reels/Inner box, 5 Inner box/Outer box = 45k Units.

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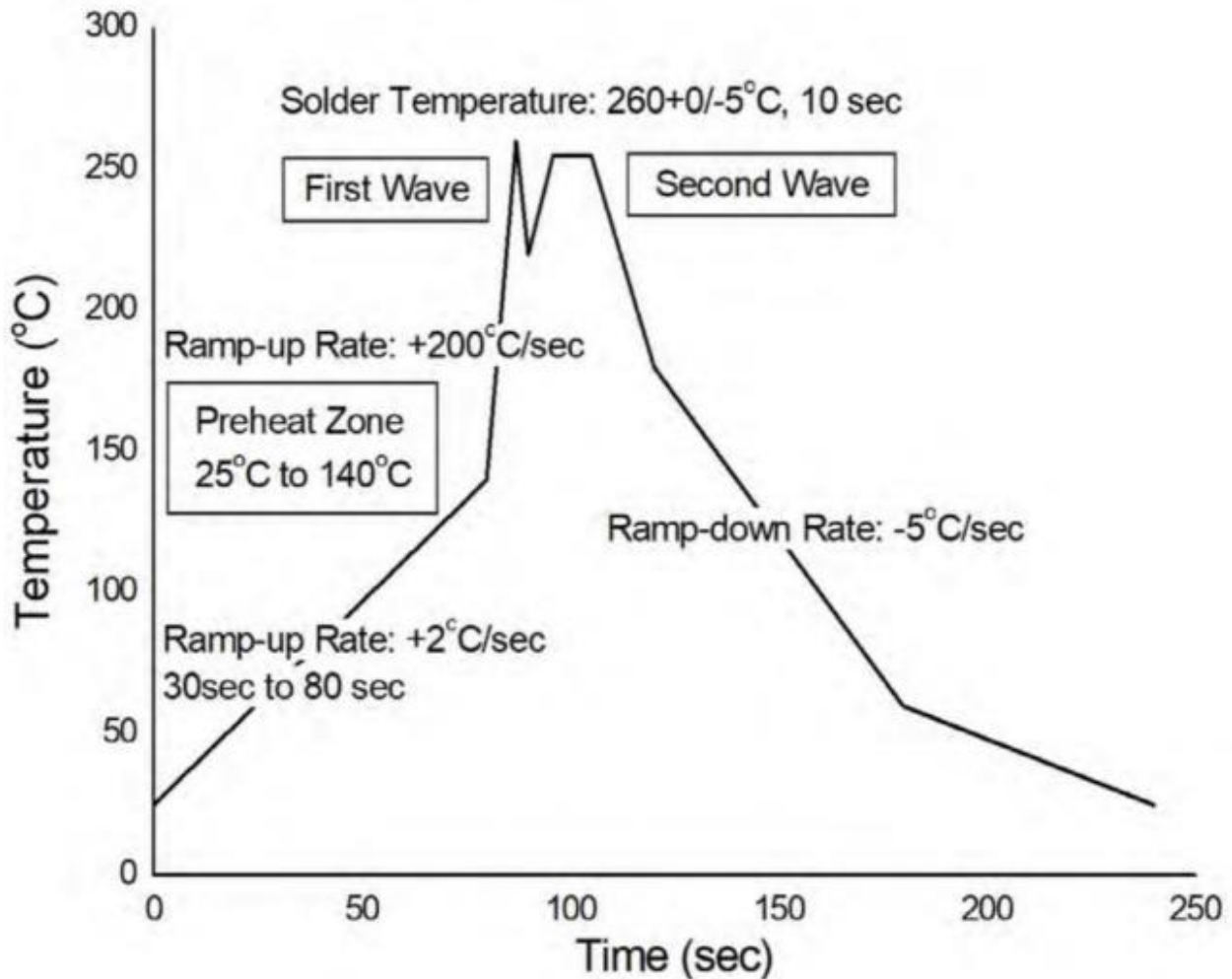
REFLOW INFORMATION

REFLOW PROFILE



IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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TEMPERATURE PROFILE OF SOLDERING
WAVE SOLDERING (JESD22-A111 COMPLIANT)

HAND SOLDERING BY SOLDERING IRON

Soldering Temperature	380+0/-5°C
Soldering Time	3 sec max.

- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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DISCLAIMER

- LYG is continually improving the quality, reliability, function and design. LYG reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- LYG makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, LYG disclaims (a) any and all liability arising out of the application or use of any product, (b) any and all liability, including without limitation special, consequential or incidental damages, and (c) any and all implied warranties, including warranties of fitness for particular
- The products shown in this publication are designed for the general use in electronic applications such as office automation, equipment, communications devices, audio/visual equipment, electrical application and instrumentation purpose, non-infringement and merchantability.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LYG sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify LYG's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.